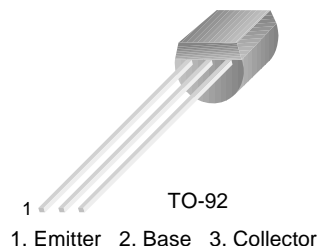


2N6520

2N6520

High Voltage Transistor

- Collector-Emitter Voltage: $V_{CEO} = -350V$
- Collector Dissipation: $P_C (max) = 625mW$
- Complement to 2N6517



PNP Epitaxial Silicon Transistor

Absolute Maximum Ratings $T_a = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{CBO}	Collector-Base Voltage	-350	V
V_{CEO}	Collector-Emitter Voltage	-350	V
V_{EBO}	Emitter-Base Voltage	-5	V
I_C	Collector Current	-500	mA
I_B	Base Current	-250	mA
P_C	Collector Power Dissipation	0.625	W
	Derate above 25	5	mW/°C
T_J	Junction Temperature	50	°C
T_{STG}	Storage Temperature	-55 ~ 150	°C

Electrical Characteristics $T_a = 25^\circ C$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Max.	Units
BV_{CBO}	Collector-Base Breakdown Voltage	$I_C = -100\mu A, I_E = 0$	-350		V
BV_{CEO}	* Collector-Emitter Breakdown Voltage	$I_C = -1mA, I_B = 0$	-350		V
BV_{EBO}	Emitter-Base Breakdown Voltage	$I_E = -10\mu A, I_C = 0$	-5		V
I_{CBO}	Collector Cut-off Current	$V_{CB} = -250V, I_E = 0$		-50	nA
I_{EBO}	Emitter Cut-off Current	$V_{EB} = -4V, I_C = 0$		-50	nA
h_{FE}	* DC Current Gain	$V_{CE} = -10V, I_C = -1mA$ $V_{CE} = -10V, I_C = -10mA$ $V_{CE} = -10V, I_C = -30mA$ $V_{CE} = -10V, I_C = -50mA$ $V_{CE} = -10V, I_C = -100mA$	20 30 30 20 15	200 200	
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C = -10mA, I_B = -1mA$ $I_C = -20mA, I_B = -2mA$ $I_C = -30mA, I_B = -3mA$ $I_C = -50mA, I_B = -5mA$		-0.30 -0.35 -0.50 -1	V V V V
$V_{BE(sat)}$	Base-Emitter Saturation Voltage	$I_C = -10mA, I_B = -1mA$ $I_C = -20mA, I_B = -2mA$ $I_C = -30mA, I_B = -3mA$		-0.75 -0.85 -0.90	V V V
$V_{BE(on)}$	Base-Emitter On Voltage	$V_{CE} = -10V, I_C = -100mA$		-2	V
f_T	* Current Gain Bandwidth Product	$V_{CE} = -20V, I_C = -10mA, f = 20MHz$	40	200	MHz
C_{ob}	Output Capacitance	$V_{CB} = -20V, I_E = 0, f = 1MHz$		6	pF
C_{EB}	Emitter-Base Capacitance	$V_{EB} = -0.5V, I_C = 0, f = 1MHz$		100	pF
t_{ON}	Turn On Time	$V_{BE(off)} = -2V, V_{CC} = -100V$ $I_C = -50mA, I_{B1} = -10mA$		200	ns
t_{OFF}	Turn Off Time	$V_{CC} = -100V, I_C = -50mA$ $I_{B1} = I_{B2} = -10mA$		3.5	ns

* Pulse Test: Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

Typical Characteristics

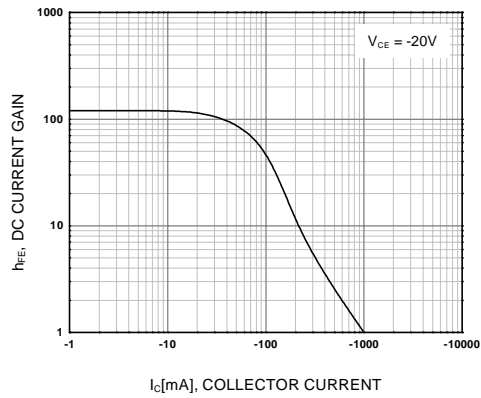


Figure 1. DC current Gain

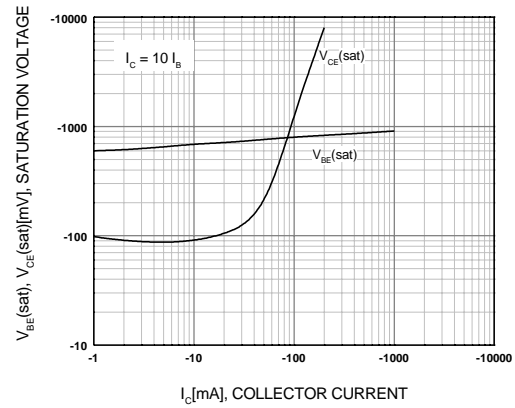


Figure 2. Base-Emitter Saturation Voltage
Collector-Emitter Saturation Voltage

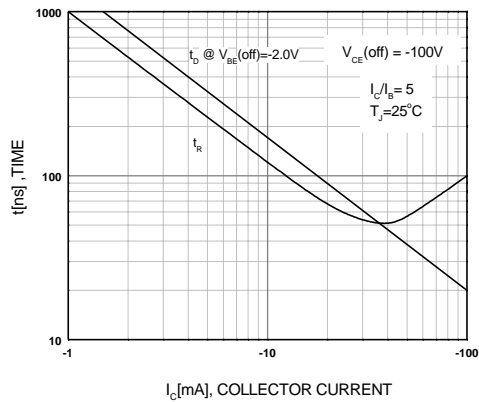


Figure 3. Turn-On Time

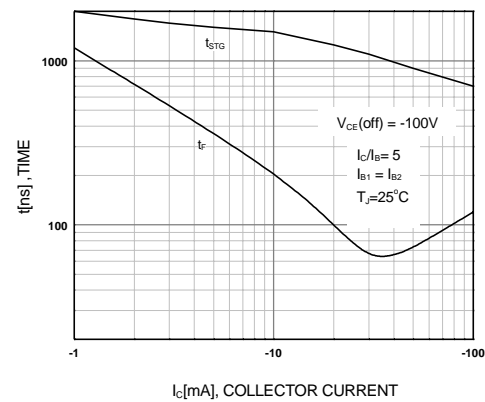


Figure 4. Turn-Off Time

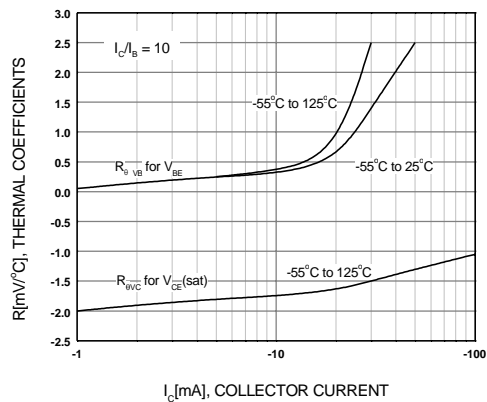


Figure 5. Temperature Coefficients

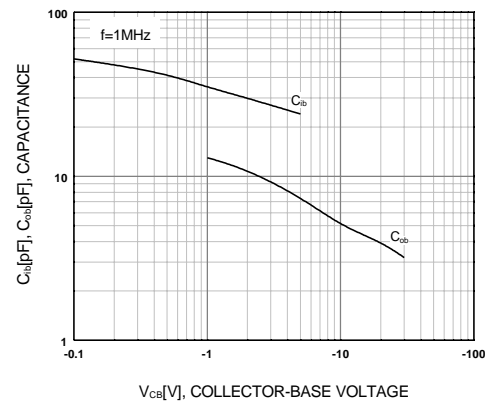


Figure 6. Capacitance

Typical Characteristics (Continued)

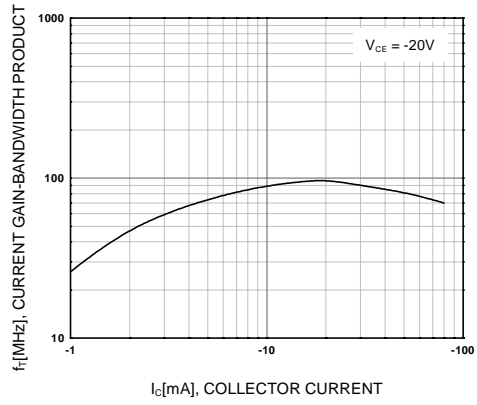
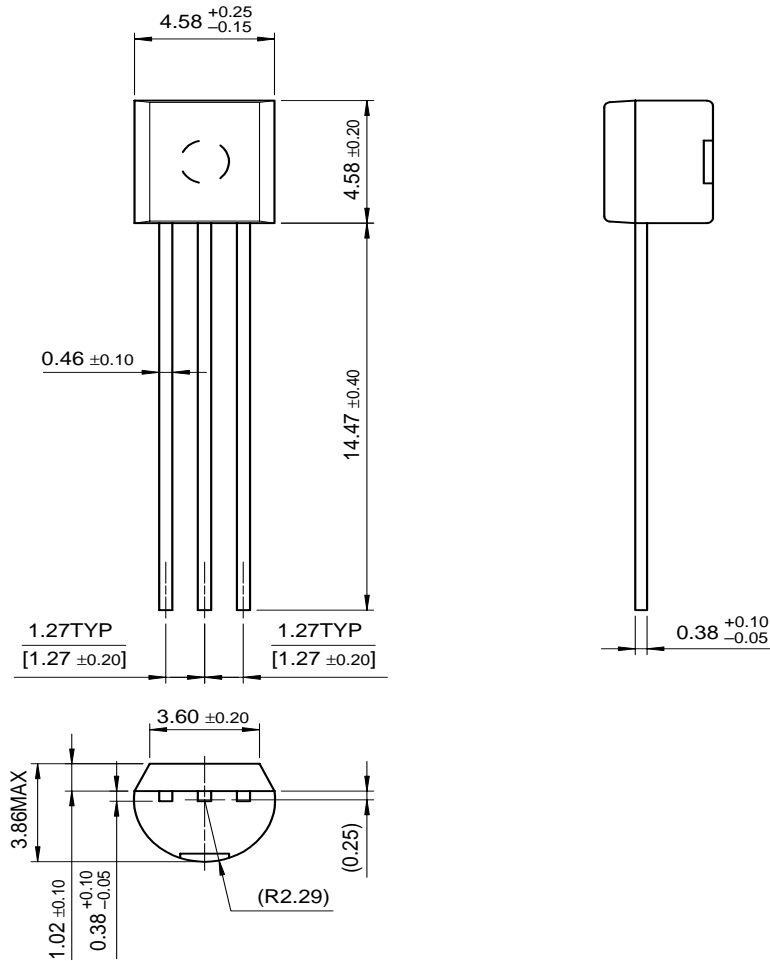


Figure 7. Current Gain Bandwidth Product

Package Dimensions

TO-92



Dimensions in Millimeters

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